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"Half Bridge" IGBT MTP (Warp 2 Speed IGBT), 70 A



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PRODUCT SUMMARY						
V _{CES}	600 V					
$V_{CE(on)}$ typical at V_{GE} = 15 V	2.1 V					
I _C at T _C = 78 °C	70 A					

FEATURES

 NPT warp 2 speed IGBT technology with positive temperature coefficient



COMPLIANT

- HEXFRED[®] antiparallel diodes with ultrasoft reverse recovery
- SMD thermistor (NTC)
- Al₂O₃ BDC
- Very low stay inductance design for high speed operation
- UL pending
- Speed 60 kHz to 150 kHz
- UL approved file E78996
- Compliant to RoHS directive 2002/95/EC
- · Designed and qualified for industrial level

BENEFITS

- Optimized for welding, UPS and SMPS applications
- Lower coduction losses and switching losses
- Low EMI, requires less snubbing
- Direct mounting to heatsink
- PCB solderable terminals

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS		
Collector to emitter voltage	V _{CES}		600	V		
Continuous collector current		T _C = 25 °C	100			
Continuous collector current	Ι _C	T _C = 78 °C	70			
Pulsed collector current	I _{CM}		300	А		
Peak switching current	I _{LM}		300	A		
Diode continuous forward current	١ _F	T _C = 78 °C	53			
Peak diode forward current	I _{FM}		200			
Gate to emitter voltage	V _{GE}		± 20	V		
RMS isolation voltage	VISOL	Any terminal to case, t = 1 min	2500			
M. in a line of the loga	Р	T _C = 25 °C	347	w		
Maximum power dissipation, IGBT	PD	T _C = 100 °C	139	vv		



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ELECTRICAL SPECIFICATIONS (T _J = 25 $^{\circ}$ C unless otherwise specified)						
PARAMETER	SYMBOL	MBOL TEST CONDITIONS		TYP.	MAX.	UNITS
Collector to emitter breakdown voltage	V _{(BR)CES}	V_{GE} = 0 V, I _C = 500 µA	600	-	-	V
		$V_{GE} = 15 \text{ V}, I_{C} = 70 \text{ A}$	-	2.1	2.4	
Collector to emitter voltage V _{CE(o}	V _{CE(on)}	$V_{GE} = 15 \text{ V}, I_{C} = 140 \text{ A}$	-	2.8	3.4	v
		V_{GE} = 15 V, I_{C} = 70 A, T_{J} = 150 °C	-	2.7	3	v
Gate threshold voltage	V _{GE(th)}	I _C = 0.5 mA	3	-	6	
Collector to emitter leaking current	1	$V_{GE} = 0 V, I_C = 600 V$	-	-	0.7	mA
CES ICE CONTROL ICE ICE ICE	ICES	V_{GE} = 0 V, I_{C} = 600 V, T_{J} = 150 °C	-	-	10	ШA
Gate to emitter leakage current	I _{GES}	$V_{GE} = \pm 20 \text{ V}$	-	-	± 250	nA

SWITCHING CHARACTERI	STICS (T _J =	= 25 °C unless otherwise specified)				-
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Total gate charge (turn-on)	Qg	I _C = 70 A	-	460	690	
Gate to emitter charge (turn-on)	Q _{ge}	V _{CC} = 480 V	-	160	250	nC
Gate to collector charge (turn-on)	Q _{gc}	V _{GE} = 15 V	-	70	130	
Turn-on switching loss	E _{on}	$R_g = 10 \Omega$	-	1.1	-	
Turn-off switching loss	E _{off}	$I_{C} = 70$ A, $V_{CC} = 480$ V, $V_{GE} = 15$ V, $L = 200 \mu$ H Energy losses include tail and diode reverse	-	0.9	-	
Total switching loss	E _{ts}	recovery, $T_J = 25 \text{ °C}$	-	2	-	
Turn-on switching loss	Eon	$R_g = 10 \Omega$	-	1.27	-	mJ
Turn-off switching loss	E _{off}	$I_{C} = 70$ A, $V_{CC} = 480$ V, $V_{GE} = 15$ V, $L = 200 \mu\text{H}$ Energy losses include tail and diode reverse	-	1.13	-	
Total switching loss	E _{ts}	recovery, $T_J = 150$ °C	-	2.4	-	
Turn-on delay time	td _{on}	$\begin{array}{c} R_{g} = 10 \; \Omega \\ I_{C} = 70 \; A, \; V_{CC} = 480 \; V, \; V_{GE} = 15 \; V, \; L = 200 \; \mu H \\ \hline \\ Energy \; losses \; include \; tail \; and \; diode \; reverse \\ \hline \\ recovery \end{array}$		314	-	-
Rise time	t _r			49	-	
Turn-off delay time	td _{off}			308	-	
Fail time	t _f			68	-	
Turn-on delay time	td _{on}	D 10.0		312	-	ns
Rise time	t _r	R_g = 10 Ω I _C = 70 A, V _{CC} = 480 V, V _{GE} = 15 V, L = 200 μH	-	50	-	
Turn-off delay time	td _{off}	Energy losses include tail and diode reverse	-	320	-	
Fail time	t _f	recovery, T _J = 150 °C	-	78	-	
Input capacitance	C _{ies}	V _{GE} = 0 V V _{CC} = 30 V		8000	-	
Output capacitane	C _{oes}			790	-	pF
Reverse transfer capacitance	C _{res}	f = 1.0 MHz	-	110	-	
Reverse BIAS safe operating area	RBSOA	$\begin{split} T_J &= 150 \ ^\circ C, \ I_C = 300 \ A \\ V_{CC} &= 400 \ V, \ V_P = 600 \ V \\ R_g &= 22 \ \Omega, \ V_{GE} = + 15 \ V \ to \ 0 \ V \end{split}$	Fullsquare			

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THERMISTOR SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Resistance	R ₀ ⁽¹⁾	$T_0 = 25 ^{\circ}C$	-	30	-	kΩ	
Sensitivity index of the thermistor material	β (1)(2)	T ₀ = 25 °C T ₁ = 85 °C	-	4000	-	к	

Notes

 $^{(1)}$ T₀, T₁ are thermistor's temperatures

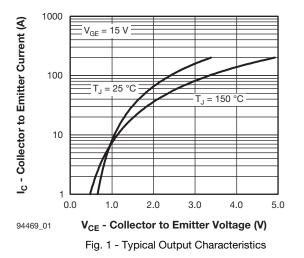
⁽²⁾
$$\frac{R_0}{R_1} = \exp\left[\beta\left(\frac{1}{T_0} - \frac{1}{T_1}\right)\right]$$
, temperature in Kelvin

DIODE SPECIFICATIONS (T _J = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
		$I_{C} = 70 \text{ A}, \text{ V}_{GE} = 0 \text{ V}$	-	1.64	2.1	
Diode forward voltage drop	V _{FM}	I _C = 140 A, V _{GE} = 0 V	-	2.1	2.4	V
	$I_{C} = 70 \text{ A}, \text{ V}_{GE} = 0 \text{ V}, \text{ T}_{J} = 150 ^{\circ}\text{C}$	-	1.69	1.9		
Diode reverse recovery time	t _{rr}	V _{CC} = 200 V, I _C = 70 A dl/dt = 200 A/μs		96	126	ns
Diode peak reverse current	l _{rr}			9.4	12.8	А
Diode recovery charge	Q _{rr}			440	750	nC
Diode reverse recovery time	t _{rr}	V _{CC} = 200 V, I _C = 70 A dl/dt = 200 A/µs T _J = 125 °C		140	194	ns
Diode peak reverse current	l _{rr}			14	19	А
Diode recovery charge	Q _{rr}			950	1700	nC

THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Operating junction IGBT, Diode	т		- 40	-	150	
temperature range Thermistor	ΤJ		- 40	-	125	°C
Storage temperature range	T _{Stg}		- 40	-	125	
Junction to case	P		-	-	0.36	
Diode	R _{thJC}		-	-	0.8	°C/W
Case to sink per module	R _{thCS}	Heatsink compound thermal conductivity = 1 W/mK	-	0.06	-	
Mounting torque to heatsink A mounting compound is recommended and the torque should be checked after 3 hours to allow for the spread of the compound. Lubricated threads.		3 ± 10 %	,	Nm		
Weight				66		g

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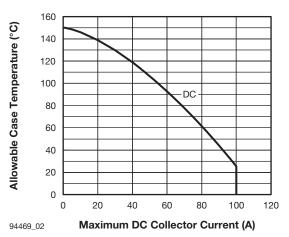
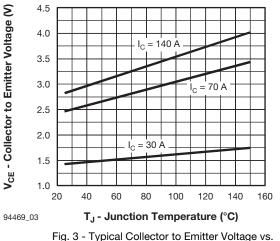
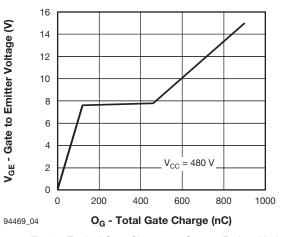


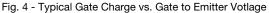
Fig. 2 - Maximum Collector Current vs. Case Temperature

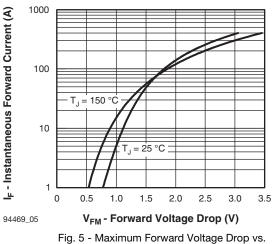




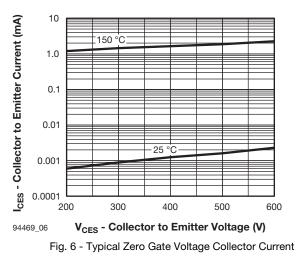
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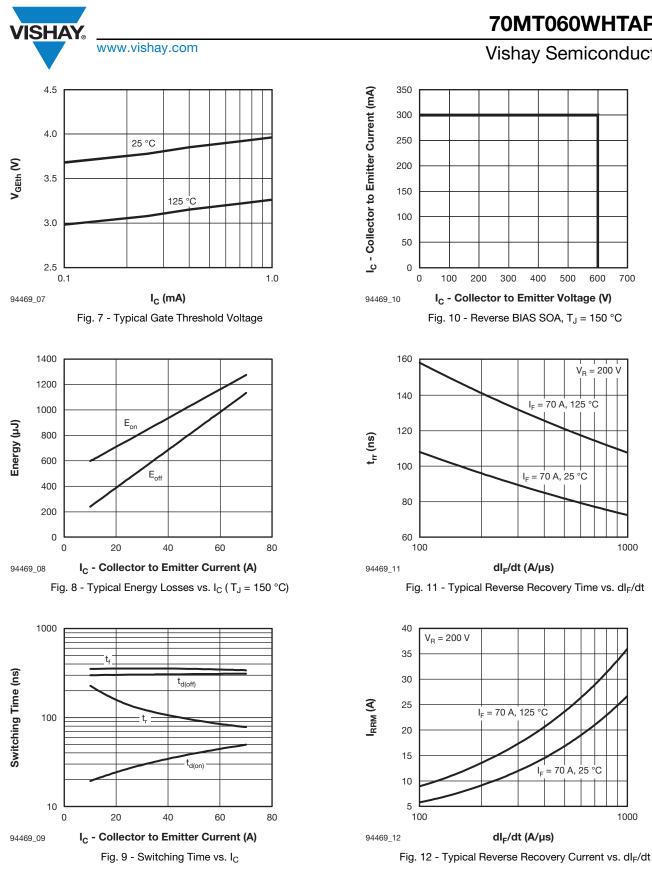




Instantaneous Forward Current



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600

700

1000

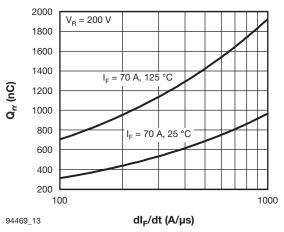
1000

°C

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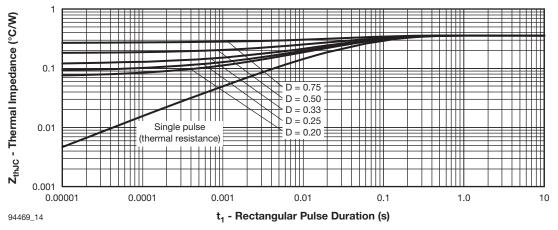
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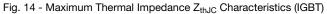
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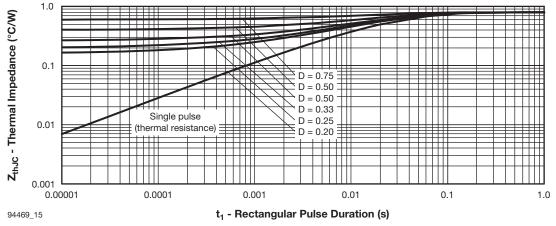


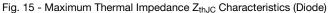
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Fig. 13 - Typical Stored Charge vs. dl_F/dt

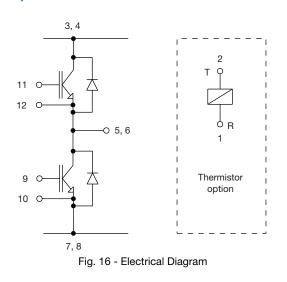




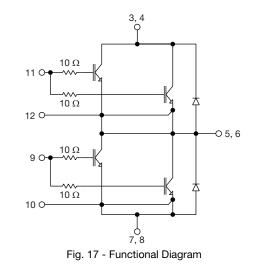




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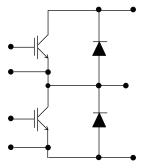


ORDERING INFORMATION TABLE

SHA

Device code	70	МТ	060	w	Н	т	Α	PbF
		2	3	4	5	6	(7)	8
	1 -		Current	rating (7	70 = 70	A)		
	2 -	- Essential part number						
	3 -	-	Voltage rating (060 = 600 V)					
	4 -	-	Speed/type (W = Warp IGBT)					
	5 -	-	Circuit c	onfigura	ation (H	= Half b	oridge)	
	6 -	-	T = Thermistor					
	7 -		A = AI_2O_3 DBC substrate					
	8 -		Lead (P	b)-free				

CIRCUIT CONFIGURATION



LINKS TO RELATED DOCUMENTS					
Dimensions	www.vishay.com/doc?95175				

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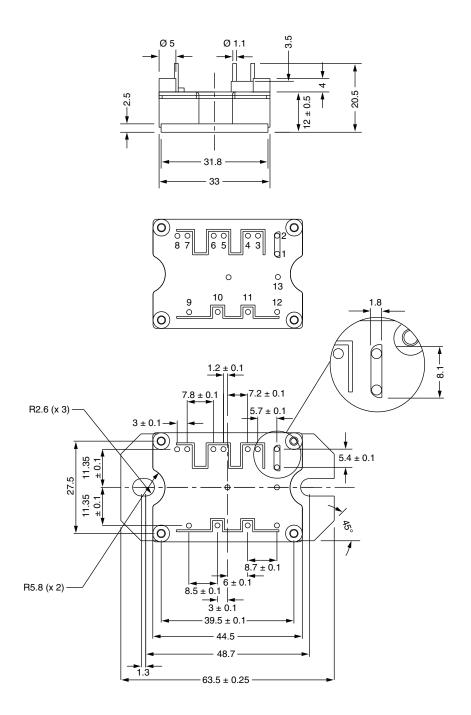
Outline Dimensions

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MTP

DIMENSIONS in millimeters



Note

• Unused terminals are not assembled in the package



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